

ABSTRACT

A polyphenylene sulfide resin composition comprising from 99.9 to 80% by weight of a polyphenylene sulfide resin and from 0.1 to 20% by weight of an aromatic group-containing oligomer, the crystallization peak temperature in temperature rise of the composition being 125°C or lower, controls occurrence of burr and is excellent in the flowability and the crystallization characteristics. Accordingly, it is especially useful as a resin composition for producing molded articles such as miniature precision parts and the like.

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